6

Distinguishing Features

- 80, 50 MHz Operation
- Triple 8-bit D/A Converters
- Optional Internal Voltage Reference
- RS-343A-Compatible Outputs
- TTL-Compatible Inputs
- +5 V CMOS Monolithic Construction
- 44-pin PLCC Package
- Typical Power Dissipation: 600 mW

Functional Block Diagram

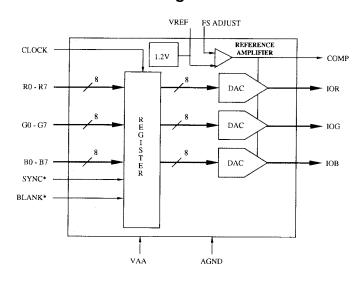
Applications

- · High-Resolution Color Graphics
- · CAE/CAD/CAM
- · Image Processing
- · Video Reconstruction
- Instrumentation

Related Products

• Bt473

DataSheet4U con



Bt121

80 MHz Monolithic CMOS Triple 8-bit VIDEODAC™

DataShee

Product Description

The Bt121 is a triple 8-bit VIDEODAC designed specifically for high-performance, high-resolution color graphics.

This device offers a higher level of integration than previous VIDEODAC designs. Included is an on-chip voltage reference to simplify use of the device.

The Bt121 generates RS-343A-compatible video signals into a doubly-terminated 75 Ω load, and RS-170-compatible video signals into a singly- terminated 75 Ω load, without requiring external buffering. Both the differential and integral linearity errors of the D/A converters are guaranteed to be a maximum of ± 1 LSB over the full temperature range.

www.DataSheet4U.com

Brooktree®

DataSheet4U.com

Brooktree Corporation • 9950 Barnes Canyon Rd. • San Diego, CA 92121-2790 (619) 452-7580 • (800) VIDEO IC • TLX: 383 596 • FAX: (619) 452-1249 L121001 Rev. F

Bt121 Brooktree®

Circuit Description

As illustrated in the functional block diagram, the Bt121 contains three 8-bit D/A converters, input registers, and a reference amplifier.

On the rising edge of CLOCK, 24 bits of color information (R0–R7, G0–G7, and B0–B7) are latched into the device and presented to the three 8-bit D/A converters.

Latched on the rising edge of CLOCK to maintain synchronization with the color data, the SYNC* and BLANK* inputs add appropriately weighted currents to the analog outputs, producing the specific output levels required for video applications as illustrated in Figure 1. Table 1 details how the SYNC* and BLANK* inputs modify the output levels.

The D/A converters on the Bt121 use a segmented architecture in which bit currents are routed to either the output or GND by a sophisticated decoding scheme. This architecture eliminates the need for precision component ratios and greatly reduces the switching transients associated with turning current sources on or off. Monotonicity and low glitch are guaranteed by use of identical current sources and current steering their outputs. An onchip operational amplifier stabilizes the full-scale output current against temperature and power supply variations.

The analog outputs of the Bt121 can directly drive a 37.5 Ω load, such as a doubly-terminated 75 Ω coaxial cable.

ESD and Latchup Considerations

Correct ESD-sensitive handling procedures are required to prevent device damage, which can produce symptoms of catastrophic failure or erratic device behavior with somewhat leaky inputs.

All logic inputs should be held low until power to the device has settled to the specified tolerance. DAC power decoupling networks with large time constants should be avoided. They could delay VAA power to the device. Ferrite beads must only be used for analog power VAA decoupling. Inductors cause a time constant delay that induces latchup.

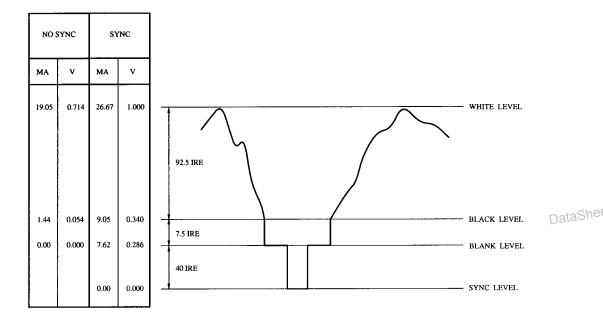
Latchup can be prevented by ensuring that all VAA pins are at the same potential and that the VAA supply voltage is applied before the signal pin voltages. The correct power-up sequence ensures that any signal pin voltage will never exceed the power supply voltage by more than +0.5 V.

DataShe

neet4U.com

DataSheet4U.com

Circuit Description (continued)



Note: 75 Ω doubly-terminated load, RSET ~ 143 Ω , and VREF = 1.23 V. RS-343A levels and tolerances are assumed on all levels.

Figure 1. Composite Video Output Waveforms.

Description	lout (mA)	SYNC*	BLANK*	DAC Input Data
WHITE	26.67	1	1	\$FF
DATA	data + 9.05	1	1	data
DATA - SYNC	data + 1.44	0	1	data
BLACK	9.05	1	1	\$00
BLACK - SYNC	1.44	0	1	\$00
BLANK	7.62	1	0	\$xx
SYNC	0	0	0	\$xx

Note: 75 Ω doubly-terminated load, SETUP = 7.5 IRE. VREF = 1.23 V and RSET ~ 143 Ω .

Table 1. Video Output Truth Table.

www.DataSheet4U.com

DataSheet4U.com

6

Brooktree® Bt121

Pin Descriptions

Description					
Composite blank control input (TTL compatible). A logical zero drives the IOR, IOG, and IOB outputs to the blanking level, as detailed in Table 1. BLANK* is latched on the rising edge of CLOCK. When BLANK* is a logical zero, the R0-R7, G0-G7, and B0-B7 inputs are ignored.					
Composite sync control input (TTL compatible). A logical zero on this input switches off a 40 IRE current source on the IOR, IOG, IOB outputs (see Figure 1). SYNC* does not override any other control or data input, as shown in Table 1; therefore, SYNC* should be asserted only during the blanking interval. It is latched on the rising edge of CLOCK.					
Red, green, and blue data inputs (TTL compatible). R0, G0, and B0 are the least-significant data bits. They are latched on the rising edge of CLOCK. Coding is binary.					
Clock input (TTL compatible). The rising edge of CLOCK latches the R0–R7, G0–G7, B0–B7, SYNC*, and BLANK* inputs. It is typically the pixel clock rate of the video system. It is recommended that the CLOCK input be driven by a dedicated TTL buffer to avoid reflection-induced jitter.					
Red, green, and blue current outputs. These high-impedance current sources can directly drive a doubly-terminated 75 Ω coaxial cable (see Figures 2 and 3 in the PC Board Layout Considerations section). All outputs, whether used or not, should have the same output load.					
Full-scale adjust control. A resistor (RSET) connected between this pin and GND controls the magnitude of the full-scale video signal (Figure 1). The IRE relationships in Figure 1 are maintained, regardless of the full-scale output current.					
The relationship between RSET and the full-scale output current on IOR, IOG and IOB is:					
$RSET(\Omega) = K * VREF(V) / IO(mA)$					
Where; K = 2,295 with SYNC*=0 K = 3,195 with SYNC*=1					

et4U.com

DataSheet4U.com

www.DataSheet4U.com

DataShee

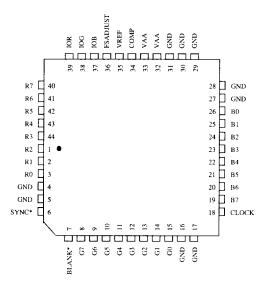
Bt121

Brooktree*

Pin Descriptions (continued)

Pin Name	Description	
СОМР	Compensation pin. This pin provides compensation for the internal reference amplifier. A 0.1 μ F ceramic capacitor in series with a resistor should be connected between this pin and the nearest VAA pin (Figures 2 and 3) for optimum settling time. Connecting the capacitor to VAA rather than to GND provides the highest possible power supply noise rejection. The COMP resistor and capacitor must be as close to the device as possible to keep lead lengths to an absolute minimum. Refer to the PC Board Layout Considerations section for critical layout criteria.	
VREF	Voltage reference input. If an external voltage reference is used (Figure 3), it must supply this input with a 1.2 V (typical) reference. A 0.1 μ F ceramic capacitor must always be used to decouple this input to GND, as shown in Figures 2 and 3. The decoupling capacitor must be as close to the device as possible to keep lead lengths to an absolute minimum. When the internal reference is used, this pin should not drive any external circuitry, except the decoupling capacitor (Figure 2).	ataShe
GND	Analog ground. All GND pins must be connected together on the same PCB plane to prevent latchup.	
VAA	Analog power. All VAA pins must be connected together on the same PCB plane to prevent latchup.	

DataSheet4U.com



et4U.com

6

Brooktree* Bt121

PC Board Layout Considerations

PC Board Considerations

The layout should be optimized for lowest noise on the Bt121 power and ground planes by providing good decoupling. The trace length between groups of VAA and GND pins should be as short as possible to minimize inductive ringing.

A well-designed power distribution network is critical to eliminating digital switching noise. The ground plane must provide a low-impedance return path for the digital circuits. A PC board with a minimum of four layers is recommended, with layers 1 (top) and 4 (bottom) for signals and layers 2 and 3 for power and

ground.

et4U.com

Component Placement

Components should be placed as close as possible to the associated VIDEODAC pin. Whenever possible, components should be placed so traces can be connected point to point.

The optimum layout enables the Bt121 to be located as close as possible to the power supply connector and the video output connector.

Ground Planes

For optimum performance, a common digital and analog ground plane is recommended.

Power Planes

Separate digital and analog power planes are recommended. The digital power plane should provide power to all digital logic on the PC board, and the analog power plane should provide power to all Bt121 power pins, VREF circuitry, and COMP and VREF decoupling. There should be at least a 1/8-inch gap between the digital power plane and the analog power plane.

The analog power plane should be connected to the digital power plane (VCC) at a single point through a ferrite bead, as illustrated in Figures 2 and 3. This bead should be located within 3 inches of the Bt121. The bead provides resistance to switching currents, acting as a resistance at high frequencies. A low-resistance bead should be used, such as Ferroxcube 5659065-3B, Fair-Rite 2743001111, or TDK BF45-4001.

Device Decoupling

For optimum performance, all capacitors should be located as close as possible to the device, and the shortest possible leads (consistent with reliable operation) should be used to reduce the lead inductance. Chip capacitors are recommended for minimum lead inductance. Radial lead ceramic capacitors may be substituted for chip capacitors and are better than axial lead capacitors for self-resonance. Values are chosen to have self-resonance above the pixel clock.

Power Supply Decoupling

The best power supply decoupling performance is obtained with a 0.1 µF ceramic capacitor, decoupling each of the VAA pins to GND. For operations above 75 MHz, a 0.1 µF capacitor in parallel with a 0.01µF chip capacitor is reccommended. The capacitors should be placed as close as possible to the device VAA and GND pins and connected with short, wide traces.

The 10 µF capacitor shown in Figures 2 and 3 is for low-frequency power supply ripple; the 0.1 µF capacitors are for high-frequency power supply noise rejection.

When a linear regulator is used, the power-up sequence must be verified to prevent latchup. A linear regulator is recommended to filter the analog power supply if the power supply noise is greater than or equal to 200 mV. This is especially important when a switching power supply is used, and the switching frequency is close to the raster scan frequency. About 10 percent of the power supply hum and ripple noise less than 1 MHz will couple onto the analog outputs.

COMP Decoupling

To optimize the settling time of the Bt121, a resistor may be added in series between the COMP capacitor and COMP pin. The series resistor damps inductive ringing on COMP, thus improving settling time.

The value of the resistor is typically 15 Ω ; however, the exact value is dependent on the PC board layout, clock rate, etc., and should be optimized for minimal settling time. An incorrect resistor value will result in degraded output performance, such as excessive ringing of the analog outputs or increased settling time.

The COMP pin and series resistor must also be decoupled to VAA, typically using a 0.1 µF ceramic capacitor. The COMP capacitor must be as close as physically possible to the COMP and VAA pins. A surface-mount ceramic chip capacitor is preferred for minimal lead inductance, which degrades the noise rejection of the circuit. Use of short, wide traces will also minimize lead inductance. www.DataSheet4U.com

To reduce low-frequency supply noise a larger COMP capacitor value may be required.

DataShee

6

Brooktree^{*} Bt121

PC Board Layout Considerations (continued)

VREF Decoupling

A 0.1 μF ceramic capacitor should be used to decouple this input to GND.

Digital Signal Interconnect

The digital inputs to the Bt121 should be isolated as much as possible from the analog outputs and other analog circuitry. Also, these input signals should not overlay the analog power plane or analog output signals.

Most of the noise on the analog outputs will be caused by excessive edge rates (less than 3 ns), overshoot, undershoot, and ringing on the digital inputs.

The digital edge rates should not be faster than necessary, as feedthrough noise is proportional to the digital edge rates. Lower-speed applications will benefit from using lower-speed logic (3–5 ns edge rates) to reduce data-related noise on the analog outputs.

Transmission lines will mismatch if the lines do not match the source and destination impedance. This will degrade signal fidelity if the line length reflection time is greater than one fourth the signal edge time (refer to Brooktree Application Notes AN-11 and AN-12). Line termination or line-length reduction is the solution 4-U For example, logic edge rates of 2 ns require line lengths of less than 4 inches without use of termination. Ringing may be reduced by damping the line with a series resistor (30–300 Ω). The RS-select inputs and RD*/WR* lines must be verified for proper levels with no ringing, undershoot, or overshoot. Ringing on these lines can cause improper operation.

Radiation of digital signals can also be picked up by the analog circuitry. This is prevented by reducing the digital edge rates (rise/fall time), minimizing ringing with damping resistors, and minimizing coupling through PC board capacitance by routing the digital signals at a 90 degree angle to any analog signals.

The clock driver and all other digital devices must be adequately decoupled to prevent noise generated by the digital devices from coupling into the analog circuitry.

Clock Interfacing

The Bt121 requires a pixel clock with monotonic clock edges for proper operation. Impedance mismatch on the pixel clock line will induce reflections on the pixel clock, which may cause erratic operation.

The Pixel Clock Pulse Width High Time and Pixel Clock Pulse Width Low Time minimum specifications (see the AC Characteristics section) must not be violated, or erratic operation can occur.

The pixel clock line must be terminated to prevent impedance mismatch. A series termination of 33–68 Ω placed at the pixel clock driver may be used, or a parallel termination may be used at the pixel clock input to the VIDEODAC. A parallel termination of 220 Ω to VCC and 330 Ω to ground will provide a Thevenin equivalent of a 110 Ω termination, which is normally sufficient to absorb reflections. The series or parallel resistor values should be adjusted to provide the optimum clock signal fidelity.

Analog Signal Interconnect

The Bt121 should be located as close as possible to the output connectors to minimize noise pickup and reflections caused by impedance mismatch.

The analog outputs are susceptible to crosstalk from ataShed digital lines; digital traces must not be routed under or adjacent to the analog output traces.

To maximize the high-frequency power supply rejection, the video output signals should not overlay the analog power plane.

For maximum performance, the analog video output impedance, cable impedance, and load impedance should be the same. The load resistor connection between the video outputs and GND should be as close as possible to the Bt121 to minimize reflections. Unused analog outputs should be connected to GND.

Analog output video edges exceeding the CRT monitor bandwidth can be reflected, producing cablelength dependent ghosts. Simple pulse filters can reduce high-frequency energy, reducing EMI and noise. The filter impedance must match the line impedance.

Analog Output Protection

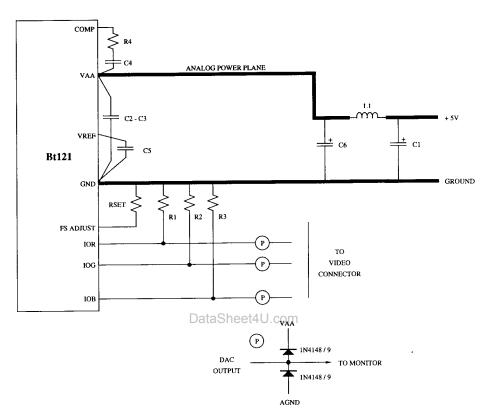
The Bt121 analog output should be protected against high-energy discharges, such as those from monitor arc-over or from hot-switching AC-coupled monitors.

The diode protection circuit shown in Figures 2 and 3 can prevent latchup under severe discharge conditions without adversely degrading analog transition times. The 1N4148/9 parts are low-capacitance, fast-switching diodes, which are also available in multiple-device packages (FSA250X or FSA270X) or surface-mountable pairs (BAV99 or MMBD7001).

www.DataSheet4U.com

DataSheet4U.

PC Board Layout Considerations (continued)



DataShee

Note: Each set of VAA and GND pins must be separately decoupled.

Location	Description	Vendor Part Number
C1 C2, C3, C4, C5 C6	33 μF tantalum capacitor 0.1 μF ceramic capacitor 10 μF capacitor	Mallory CSR13F336KM Erie RPE112Z5U104M50V Mallory CSR13G106KM
L1 R1, R2, R3 R4 RSET	ferrite bead 75 Ω 1% metal film resistor 15 Ω 1% metal film resistor 143 Ω 1% metal film resistor	Fair-Rite 2743001111 Dale CMF-55C Dale CMF-55C Dale CMF-55C

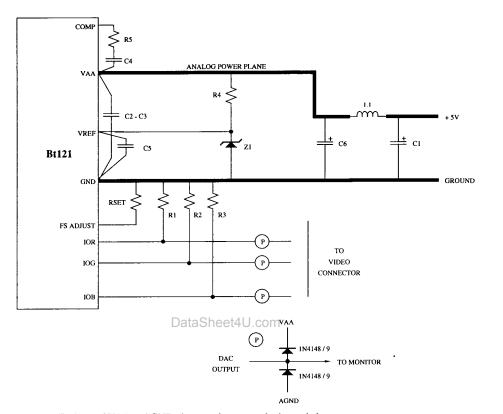
DataSheet4U.com

The vendor numbers above are listed only as a guide. Substitution of devices with similar characteristics will not affect the performance of the Bt121. www.DataSheet4U.com

Figure 2. Typical Connection Diagram and Parts List (Internal Reference).

Brooktree*

PC Board Layout Considerations (continued)



Note: Each set of VAA and GND pins must be separately decoupled.

Location	Description	Vendor Part Number
C1	33 µF tantalum capacitor	Mallory CSR13F336KM
C2, C3, C4, C5	0.1 μF ceramic capacitor	Erie RPE112Z5U104M50V
C6	10 μF capacitor	Mallory CSR13G106KM
Li	ferrite bead	Fair-Rite 2743001111
R1, R2, R3	75 Ω 1% metal film resistor	Dale CMF-55C
R4	$1000 \Omega 5\%$ metal film resistor	
R5	15 Ω 1% metal film resistor	Dale CMF-55C
RSET	143 Ω 1% metal film resistor	Dale CMF-55C
Z1	1.2 V voltage reference	National Semiconductor LM385BZ-1.2

Note: The vendor numbers above are listed only as a guide. Substitution of devices with similar characteristics will not affect the performance of the Bt121. www.DataSheet4U.com

Figure 3. Typical Connection Diagram and Parts List (External Reference).

j

DataShee

VIDEODACS

DataSheet4U.com

Bt121 Brooktree[®]

Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Units
Power Supply	VAA				
80, 66 MHz Parts	ŀ	4.75	5.00	5.25	V
50, 35 MHz Parts	i l	4.5	5.00	5.5	V
Ambient Operating Temperature	TA	0		+70	°C
Output Load	RL		37.5		Ω
External Reference Voltage	VREF	1.11	1.235	1.36	V
FS ADJUST Resistor	RSET		143		Ω

et4U.com

DataShee

Absolute Maximum Ratings

Parameter	Symbol	Min	Тур	Max	Units
VAA (measured to GND)				7.0	V
Voltage on Any Signal Pin (Note 1)	DataS	h GNP t0.5or	n	VAA + 0.5	V
Analog Output Short Circuit					
Duration to Any Power Supply				•	
or Common	ISC		indefinite		
				40.5	0.0
Ambient Operating Temperature	TA	-55		+125	°C °C
Storage Temperature	TS	-65	İ	+150	°C
Junction Temperature	TJ	İ		+150	°C
	m. 100*			220	°C
Vapor Phase Soldering	TVSOL			220	-0
(1 minute)					
		ļ		1	
		1			
ļ					
Ì					

Stresses above those listed undef-"Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 1: This device employs high-impedance CMOS devices on all signal pins. It should be handled as an ESD-sensitive device. Voltage on any signal pin that exceeds the absolute maximum ratings (especially dataSheet4U.com relative to VAA or between VAA pins) can induce destructive latchup.

DataSheet4U.com

Bt121

Brooktree*

DC Characteristics

Parameter	Symbol	Min	Тур	Max	Units
Resolution (each DAC) Accuracy (each DAC) Integral Linearity Error Differential Linearity Error Gray Scale Error External Reference Internal Reference Monotonicity Coding	IL DL	8	8 guaranteed	8 ±1 ±1 ±5 ±10	Bits LSB LSB % Gray Scale % Gray Scale Binary
Digital Inputs Input High Voltage Input Low Voltage Input High Current (Vin = 2.4 V) Input Low Current (Vin = 0.4 V) Input Capacitance (f = 1 MHz, Vin = 2.4 V)	VIH VIL IIH IIL CIN	2.0 GND-0.5		VAA + 0.5 0.8 1 -1 7	V V μΑ μΑ pF
Digital Output Output High Voltage (IOH = -400 μA) Output Low Voltage (IOL = 400 μA) Output Capacitance	voh vol Deboute	2.4 et4U.com		0.4	V V pF
Analog Outputs Gray Scale Current Range Output Current White Level Relative to Blank White Level Relative to Black Black Level Relative to Blank Sync Level on IOR, IOG, IOB LSB Size DAC-to-DAC Matching Output Compliance Output Impedance Output Impedance (f = 1 MHz, IOUT = 0 mA) Internal VREF Voltage Range	VOC ROUT COUT	17.69 16.74 0.95 6.29 -0.5	19.05 17.62 1.44 7.62 69.72 2 10 30	20 20.40 18.50 1.90 7.94 5 +1.4	mA mA mA mA μA V kΩ pF
Power Supply Rejection Ratio (Note 1) (COMP = 0.01 μF, f = 1 kHz)	IVREF PSRR		0.2	0.5	μΑ % / % ΔVAA

Test conditions (unless otherwise specified): "Recommended Operating Conditions" with external voltage reference, RSET = 143 Ω , and VREF = 1.235 V. As the above parameters are guaranteed over the full temperature range, temperature coefficients are not specified or required. Typical values are based on nominal temperature, i.e., room temperature, and nominal voltage, i.e., 5 V.

DataSheet4U.com

When the internal voltage reference is being used, RSET may require adjustment to meet these limits.

Note 1: Guaranteed by characterization, not tested.

DataShee

VIDEODACS 6-83

Brooktree*

Bt121

AC Characteristics

		80	MHz Devi	ces	50 MHz Devices			
Parameter	Symbol	Min	Тур	Max	Min	Тур	Max	Units
Clock Rate	Fmax			80		_	50	MHz
Data and Control Setup Time Data and Control Hold Time	1 2	3			3 3			ns ns
Clock Cycle Time Clock Pulse Width High Time Clock Pulse Width Low Time	3 4 5	12.5 4 4			20 7 7			ns ns ns
Analog Output Delay Analog Output Rise/Fall Time Analog Output Settling Time Clock and Data Feedthrough (Note 1) Glitch Impulse (Note 1) DAC-to-DAC Crosstalk Analog Output Skew	6 7 8		3 12.5 -30 75 -23 0	30		3 15.5 -30 75 -23 0	30	ns ns dB pV - sec dB ns
Pipeline Delay		2	2	2	2	2	2	Clock
VAA Supply Current (Note 2)	IAA [DataSh	eetøJJ.c	om ₁₀		95	110	mA

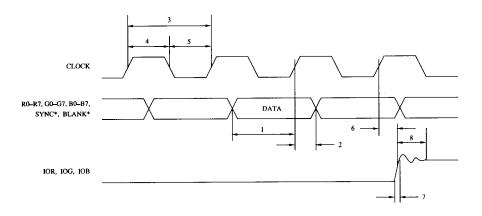
DataShee

Test conditions (unless otherwise specified): "Recommended Operating Conditions" using external voltage reference with RSET = $143~\Omega$ and VREF = 1.235~V. TTL input values are 0-3~V with input rise/fall times $\le 4~n$ s, measured between the 10-percent and 90-percent points. Timing reference points at 50 percent for inputs and outputs. Analog output load $\le 10~pF$ and SENSE* output load $\le 50~pF$. See timing notes in Figure 4. As the above parameters are guaranteed over the full temperature range, temperature coefficients are not specified or required. Typical values are based on nominal temperature, i.e., room temperature, and nominal voltage, i.e., 5~V.

- Note 1: Clock and data feedthrough is a function of the number of edge rates, and the amount of overshoot and undershoot on the digital inputs. For this test, the digital inputs have a $1 \text{ k}\Omega$ resistor to the regular PCB ground plane and are driven by 74HC logic. Settling time does not include clock and data feedthrough. Glitch impulse includes clock and data feedthrough, and -3 dB test bandwidth = 2x clock rate.
- Note 2: At Fmax. IAA (typ) at VAA = 5.0 V. IAA (max) at VAA = 5.25 V.

Ū

Timing Waveforms



et4U.com

- Note 1: Output delay is measured from the 50-percent point of the rising edge of CLOCK to the 50-percent point of full-scale transition.
- Note 2: Settling time is measured from the 50-percent point of full-scale transition to the output remaining within ±1 LSB.
- Note 3: Output rise/fall time is measured between the 10-percent and 90-percent points of full-scale transition.

DataSheet4U.com

Figure 4. Input/Output Timing.

Ordering Information

Model Number	Speed	Package	Ambient Temperature Range
Bt121KPJ80	80 MHz	44-pin Plastic J-Lead	0° to +70° C
Bt121KPJ50	50 MHz	44-pin Plastic J-Lead	0° to +70° C